

CHIPMOS TECHNOLOGIES BERMUDA LTD  
Form SC 13D  
November 27, 2009

**Washington, D.C. 20549**

## **SCHEDULE 13D**

**Under the Securities Exchange Act of 1934**

**ChipMOS TECHNOLOGIES (Bermuda) LTD.**

**(Name of Issuer)**

**Common Stock, Par Value US\$0.01 Per Share**

**(Title of Class of Securities)**

**G2110R106**

**(CUSIP Number)**

**Julia Wei**

**ThaiLin Semiconductor Corp.**

**No. 4 Jen-De Road Fongshan Village,**

**Hukou Hsinchu County, Taiwan**

**Tel (886) 3-5985959**

**(Name, Address and Telephone Number of Person Authorized to Receive Notices and Communications)**

**September 29, 2009**

**(Date of Event which Requires Filing of this Statement)**

If the filing person has previously filed a statement on Schedule 13G to report the acquisition which is the subject of this Schedule 13D, and is filing this schedule because of Rule 13d-1(e), (f) or (g), check the following box .

SCHEDULE 13D

CUSIP NO. G2110R106

1 NAME OF REPORTING PERSON

S.S. OR I.R.S. IDENTIFICATION NO. OF ABOVE PERSON

2 ThaiLin Semiconductor Corp.  
CHECK THE APPROPRIATE BOX IF A MEMBER OF A GROUP

(a)  (b)

3 SEC USE ONLY

4 SOURCE OF FUNDS

OO

5 AF  
CHECK BOX IF DISCLOSURE OF LEGAL PROCEEDINGS IS REQUIRED PURSUANT TO ITEMS 2(d) or 2(e)

..

6 CITIZENSHIP OR PLACE OF ORGANIZATION

Republic of China

NUMBER OF 7 SOLE VOTING POWER

SHARES

BENEFICIALLY 20,866,088  
OWNED BY 8 SHARED VOTING POWER

EACH 9 SOLE DISPOSITIVE POWER

REPORTING

PERSON 20,866,088  
WITH 10 SHARED DISPOSITIVE POWER

11 AGGREGATE AMOUNT BENEFICIALLY OWNED BY EACH REPORTING PERSON

20,866,088  
12 CHECK BOX IF THE AGGREGATE AMOUNT IN ROW (11) EXCLUDES CERTAIN SHARES

..  
13 PERCENT OF CLASS REPRESENTED BY AMOUNT IN ROW (11)

21.1%  
14 TYPE OF REPORTING PERSON

CO

(1) Based on 98,751,012 ordinary shares of the Issuer issued and outstanding.

**Item 1. Security and Issuer**

This Schedule 13D (this Schedule 13D ) is filed by ThaiLin Semiconductor Corp. ( ThaiLin ).

The class of equity securities to which this Schedule 13D relates is the common stock, par value US\$0.01 per share (the Common Shares ), of ChipMOS TECHNOLOGIES (Bermuda) LTD. (the Company ), a Bermuda company, whose principal executive office is located at No. 1, R&D Road 1, Hsinchu Science Park, Hsinchu, Republic of China.

**Item 2. Identity and Background**

On September 29, 2009, the Company entered into a Convertible Bond Exchange Agreement with ThaiLin, which is 42.9% owned by the Company's wholly-owned subsidiary, ChipMOS TECHNOLOGIES INC., pursuant to which the Company agreed to exchange US\$9,000,000 principal amount of the Company's 1.75% Convertible Senior Notes due 2009 (the 2009 Notes ) held by ThaiLin for US\$3,150,000 principal amount of 10% Convertible Senior Bonds due 2014 (the 10% Bonds ) and US\$5,850,000 principal amount of 8% Convertible Senior Bonds due 2014 (the 8% Bonds ), and together with the 10% Bonds, the New Bonds ).

Also on September 29, 2009, the Company entered into a Convertible Bond Purchase Agreement with ThaiLin pursuant to which ThaiLin agreed to purchase from the Company and the Company agreed to issue and sell to ThaiLin US\$10,000,000 in principal amount of 8% Bonds.

The 10% Bonds and the 8% Bonds will be convertible into Common Shares at a conversion price of US\$1.50 and US\$1.25 per share, respectively, subject to anti-dilution adjustments under certain circumstances. The 10% Bonds and the 8% Bonds pay interest on a quarterly basis at the rates of 10% per annum and 8% per annum, respectively. The Company has the option, subject to the satisfaction of certain conditions, of paying interest (and certain make-whole amounts) on the New Bonds in cash, Common Shares or a combination of Common Shares and cash.

**Item 3. Source and Amount of Funds or Other Consideration**

In exchange for the US\$10,000,000 new bonds obtained through the Convertible Bond Purchase Agreement, ThaiLin paid the Company US\$10,000,000, and the source of those funds was the working capital of ThaiLin.

**Item 4. Purpose of Transaction**

The exchange and purchase of the New Bonds by ThaiLin is for investment purposes.

**Item 5. Interest in Securities of the Issuer**

- (a) As of the date of this Schedule 13D, ThaiLin is the beneficial owner of, in the aggregate of 20,866,088 Common Shares, which represents 21.1% of the Company's issued and outstanding Common Shares. Of these 20,866,088 Common Shares, 14,780,000 are deemed beneficially owned by ThaiLin as they may be acquired upon conversion of the New Bonds.
- (b) The percentage used in this Schedule 13D are calculated based on 83,971,012 issued and outstanding Common Shares plus 14,780,000 that may be acquired upon conversion of the New Bonds.
- (c) The information contained in table form in Rows 7 through 11 to this Schedule 13D, which relates to beneficial ownership, voting and disposition of Common Shares, is hereby incorporated by reference. ThaiLin has the sole power to vote and dispose of the 20,866,088 Common Shares held by it.

**Item 6. Contracts, Arrangements, Understandings or Relationship with Respect to Securities of the Issuer**

See Item 2 above.

**Item 7. Material to be Filed as Exhibits**

***Exhibits:***

(i) Convertible Bond Exchange Agreement

(ii) Convertible Bond Purchase Agreement

**SIGNATURE**

After reasonable inquiry and to the best of my knowledge and belief, I certify that the information set forth in this statement is true, complete and correct.

Date: November 26, 2009

FOR AND ON BEHALF OF  
ThaiLin Semiconductor Corp.

By: /S/ LAFAIR CHO  
Name: **Lafair Cho**  
Title: **President**